

FGH40T65UPD 650 V, 40 A Field Stop Trench IGBT

Features

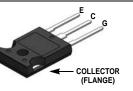
- Maximum Junction Temperature : $T_J = 175^{\circ}C$
- Positive Temperaure Co-efficient for easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.65 V(Typ.) @ I_C = 40 A$
- 100% of Parts Tested I_{LM(2)}
- High Input Impedance
- Tightened Parameter Distribution
- RoHS Compliant
- Short-circuit Ruggedness > 5us @25°C

General Description

Using innovative field stop trench IGBT technology, Fairchild[®]'s new series of field stop trench IGBTs offer optimum performance for solar inverter, UPS, welder, and digital power generator where low conduction and switching losses are essential.

Applications

- Solar Inverter, UPS, Welder, Digital Power Generator
- Telecom, ESS





Absolute Maximum Ratings

Symbol	Descriptior	۱	Ratings	Unit
V _{CES}	Collector to Emitter Voltage		650	V
V _{GES}	Gate to Emitter Voltage		± 20	V
	Collector Current	@ T _C = 25°C	80	A
I ^C	Collector Current	@ T _C = 100°C	40	A
I _{CM (1)}	Pulsed Collector Current		120	A
I _{LM (2)}	Clamped Inductive Load Current	@ T _C = 25°C	120	A
I _F	Diode Forward Current	@ T _C = 25°C	40	A
	Diode Forward Current	@ T _C = 100 ^o C	20	A
I _{FM(1)}	Pulsed Diode Maximum Forward Current		120	A
P _D	Maximum Power Dissipation	@ T _C = 25°C	268	W
	Maximum Power Dissipation	@ T _C = 100 ^o C	134	W
SCWT	Short Circuit Withstand Time	@ T _C = 25 ^o C	5	us
TJ	Operating Junction Temperature		-55 to +175	°C
T _{stg}	Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Notes:

1: Repetitive rating: Pulse width limited by max. junction temperature

2: Ic = 120A, Vce = 400V, Rg = 15Ω

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	-	0.56	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	1.71	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	-	40	°C/W

April 2013

Package Marking and Ordering Information

Device Marking Device		Package	Æco Status	Packing Type	Qty per Tube	
FGH40T65UPD	FGH40T65UPD	TO-247	-	-	30ea	

For Fairchild's definition of "green" Eco Status, please visit: <u>http://www.fairchildsemi.com/company/green/rohs_green.html</u>.

Electrical Characteristics of the IGBT T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 1mA$	650	-	-	V
$\frac{\Delta BV_{CES}}{\Delta T_{J}}$	Temperature Coefficient of Breakdown Voltage	V _{GE} = 0V, I _C = 250uA	-	0.6	-	V/ºC
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$	-	-	250	μA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$	-	-	±400	nA
On Charac	teristics					
V _{GE(th)}	G-E Threshold Voltage	I_{C} = 40mA, V_{CE} = V_{GE}	4.0	6.0	7.5	V
		I _C = 40A, V _{GE} = 15V	-	1.65	2.3	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	$I_{C} = 40A, V_{GE} = 15V,$ $T_{C} = 175^{o}C$	-	2.1	-	V
Dynamic C	haracteristics	·				
C _{ies}	Input Capacitance		-	2730	3630	pF
C _{oes}	Output Capacitance	$V_{CE} = 30V$, $V_{GE} = 0V$,	-	82	110	pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz	-	48	72	pF
Switching	Characteristics	-				
t _{d(on)}	Turn-On Delay Time		-	20	26	ns
t _r	Rise Time		-	26	34	ns
t _{d(off)}	Turn-Off Delay Time	V _{CC} = 400V, I _C = 40A,	-	144	187	ns
t _f	Fall Time	$R_G = 7\Omega$, $V_{GE} = 15V$,	-	17	22	ns
Eon	Turn-On Switching Loss	Inductive Load, T _C = 25°C	-	1.59	2.1	mJ
E _{off}	Turn-Off Switching Loss		-	0.58	0.76	mJ
E _{ts}	Total Switching Loss		-	2.17	2.86	mJ
t _{d(on)}	Turn-On Delay Time		-	19	-	ns
t _r	Rise Time]	-	38	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{CC} = 400V, I _C = 40A,	-	153	-	ns
t _f	Fall Time	$R_{G} = 7\Omega, V_{GE} = 15V,$	-	60	-	ns
Eon	Turn-On Switching Loss	Inductive Load, T _C = 175 ^o C	-	1.84	-	mJ
E _{off}	Turn-Off Switching Loss		-	0.98	-	mJ
E _{ts}	Total Switching Loss		-	2.82	-	mJ
T _{SC}	Short Circuit Withstand Time	V_{GE} = 15V, V_{CC} =400V, R _G = 10 Ω	5	-	-	US

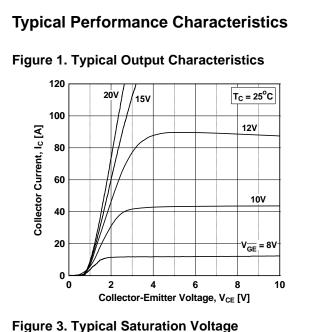
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Electrical Characteristics of the IGBT (Continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
Qg	Total Gate Charge		-	177	265	nC
Q _{ge}	Gate to Emitter Charge	V _{CE} = 400V, I _C = 40A, V _{GE} = 15V	-	23	35	nC
Q _{gc}	Gate to Collector Charge	VGE - 13V	-	100	150	nC

Electrical Characteristics of the Diode $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V _{FM} Diode Forward Voltage	Diode Forward Voltage	I _F = 20A	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	2.1	2.7	V
	IF = 2011	T _C = 175 ^o C	-	1.9	-	v	
E _{rec}	Reverse Recovery Energy		T _C = 175°C	-	96	-	uJ
t _{rr}	Diode Reverse Recovery Time	I _F = 20A, dI _F /dt = 200A/μs	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	33	43	ns
٩r		$F = 20A, 0F/01 = 200A/\mu S$	T _C = 175 ^o C	-	128	-	110
Q _{rr}	Diode Reverse Recovery Charge		T _C = 25°C	-	53	74	nC
~11	2.000 Horosof Roborory Charge		$T_{C} = 175^{\circ}C$	-	341	-	



gure 3. Typical Saturation Volta Characteristics

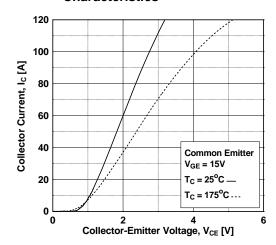


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

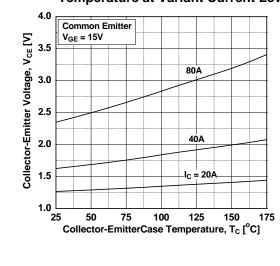


Figure 2. Typical Output Characteristics

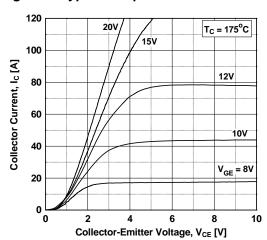


Figure 4. Transfer Characteristics

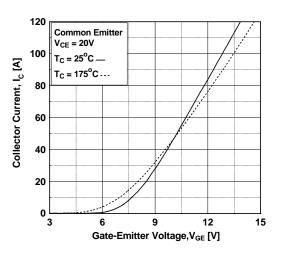
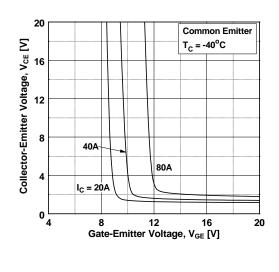


Figure 6. Saturation Voltage vs. V_{GE}



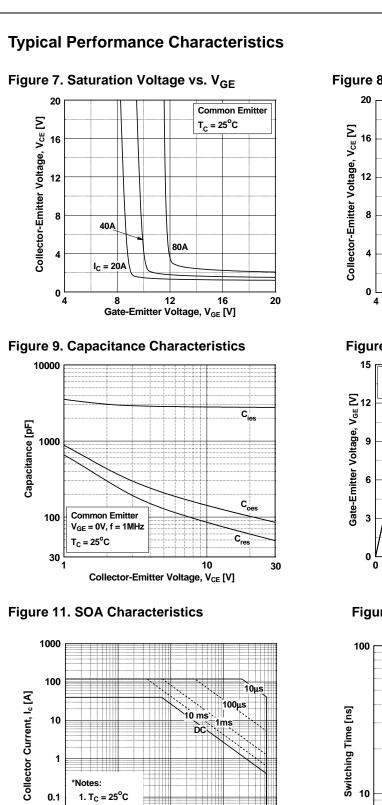
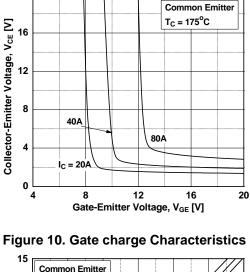


Figure 8. Saturation Voltage vs. V_{GE}



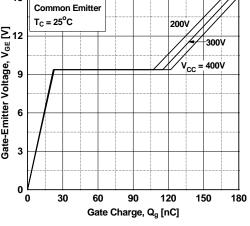
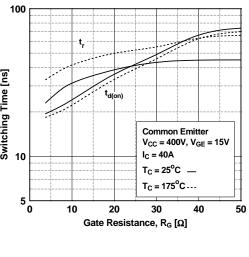


Figure 12. Turn-on Characteristics vs. Gate Resistance



0.01 └ 0.1 2. T_J = 175^oC

3. Single Pulse

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Collector-Emitter Voltage, V_{CE} [V]

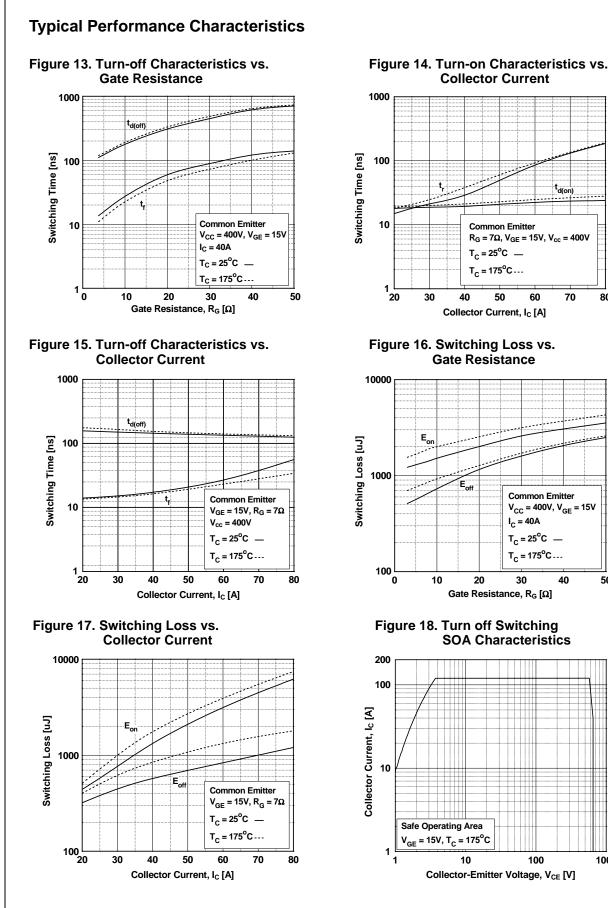
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1000

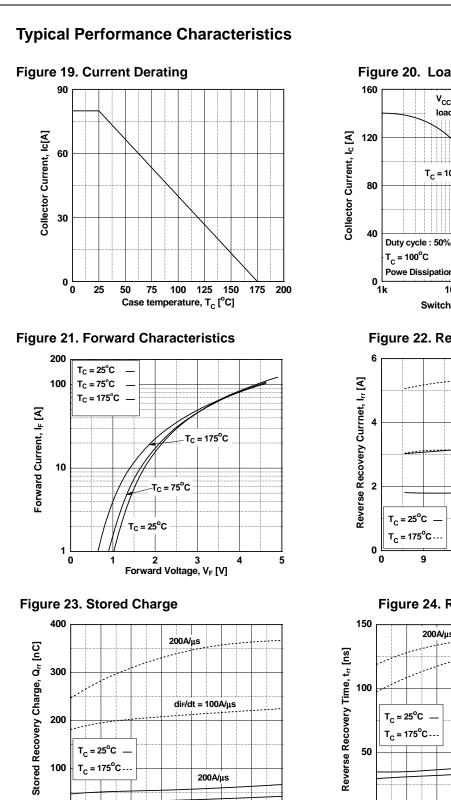


80

50



1000



di⊧/dt = 100A/µs

30

35

40

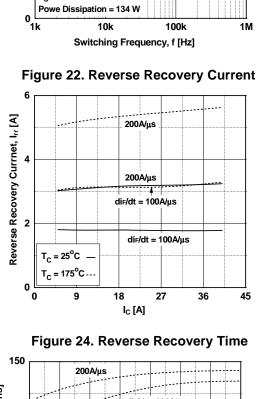
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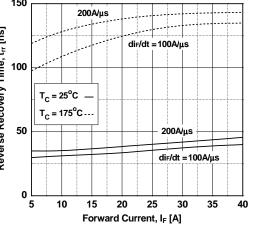
Figure 20. Load Current Vs. Frequence

load Current : peak of square wave

 $V_{CC} = 400V$

 $T_{C} = 100^{\circ}C$





0

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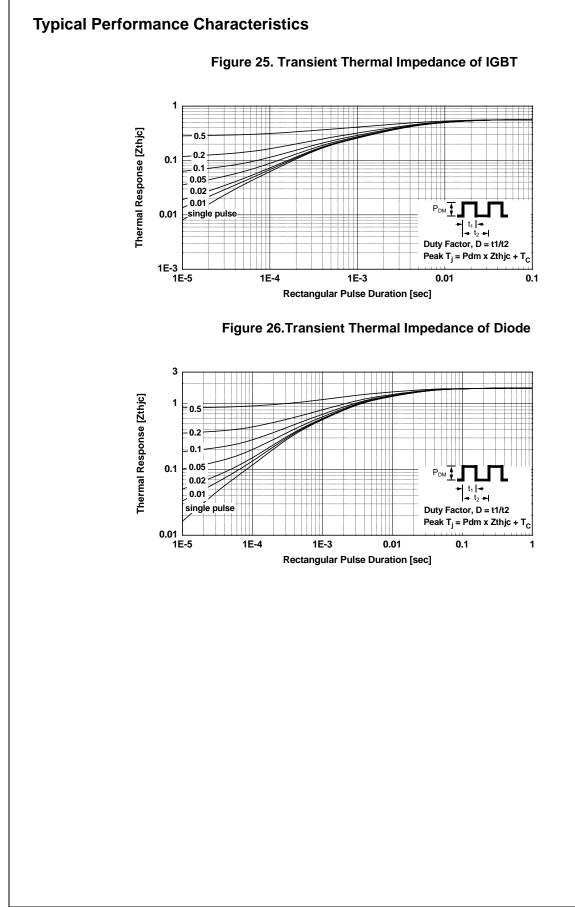
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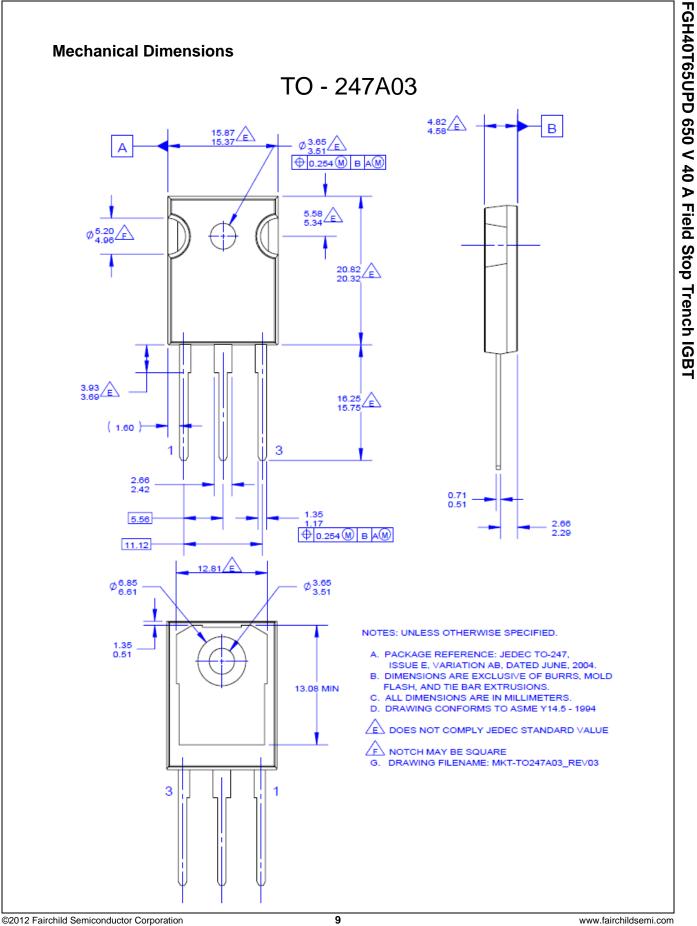
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Forwad Current, IF [A]







FGH40T65UPD Rev. C0



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